

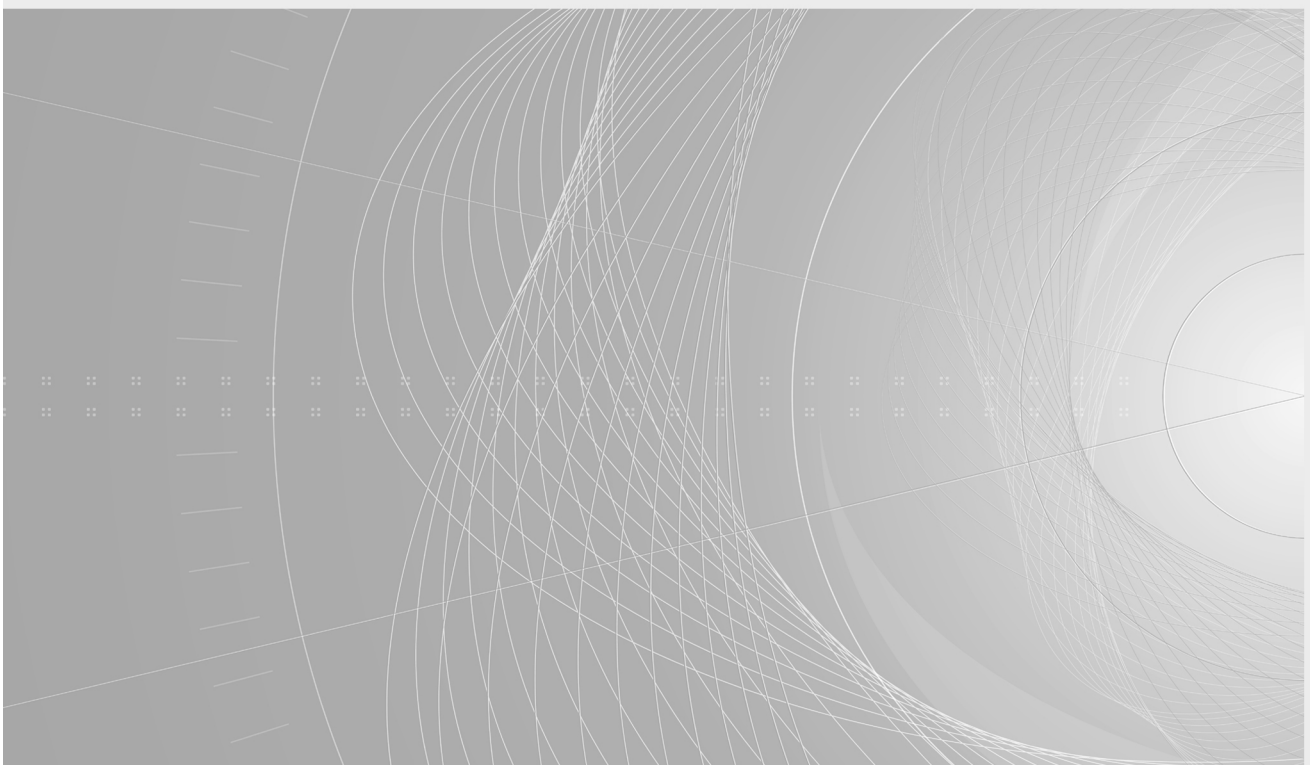
INTERNATIONAL STANDARD

**Materials for printed boards and other interconnecting structures –
Part 4-1: Sectional specification set for prepreg materials, unclad (for the
manufacture of multilayer boards) – Epoxide woven E-glass prepreg of defined
flammability**

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**MATERIALS FOR PRINTED BOARDS AND OTHER
INTERCONNECTING STRUCTURES –**
**Part 4-1: Sectional specification set for prepreg materials,
unclad (for the manufacture of multilayer boards) –
Epoxy woven E-glass prepreg of defined flammability**

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The text of this standard is based on the following documents:

FDIS	Report on voting
91/739/FDIS	91/747/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

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